

# Single/Dual, Ultra-Fast, Low-Power Precision TTL Comparators

## ABSOLUTE MAXIMUM RATINGS

Positive Supply Voltage .....+7V  
 Negative Supply Voltage .....-7V  
 V+ to V- .....+13V  
 Differential Input Voltage .....+15V  
 Input Voltage (Referred to V-) .....-0.3V to +14V  
 Latch Pin Voltage .....Equal to Supplies  
 Continuous Output Current.....±20mA  
 Continuous Power Dissipation (T<sub>A</sub> = +70°C)  
     8-Pin Plastic DIP (derate 9.09mW/°C above +70°C) ...727mW

8-Pin SO (derate 5.88mW/°C above +70°C).....471mW  
 8-Pin µMAX (derate 4.5mW/°C above +70°C) .....362mW  
 16-Pin Plastic DIP (derate 10.53mW/°C above +70°C)842mW  
 16-Pin Narrow SO (derate 8.70mW/°C above +70°C) .696mW  
 Operating Temperature Ranges:  
 MAX91\_C\_ .....0°C to +70°C  
 MAX91\_E\_ .....-40°C to +85°C  
 Storage Temperature Range .....-65°C to +150°C  
 Lead Temperature (soldering, 10s) .....+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## ELECTRICAL CHARACTERISTICS

V+ = +5V, V- = -5V, V<sub>Q</sub> = 1.4V, V<sub>LE</sub> = 0V, T<sub>A</sub> = T<sub>MIN</sub> to T<sub>MAX</sub>, unless otherwise noted. Typical values are at T<sub>A</sub> = +25°C.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Input Offset Voltage (Note 2)	V <sub>OS</sub>	R <sub>S</sub> ≤ 100Ω	T <sub>A</sub> = +25°C		0.1	2	mV
			T <sub>A</sub> = T <sub>MIN</sub> to T <sub>MAX</sub>			3	
Offset Drift	TCV <sub>OS</sub>				2		µV/°C
Input Offset Current (Note 2)	I <sub>OS</sub>	T <sub>A</sub> = +25°C			0.3	0.5	µA
		T <sub>A</sub> = T <sub>MIN</sub> to T <sub>MAX</sub>				1	
Input Bias Current	I <sub>B</sub>	T <sub>A</sub> = +25°C			2	5	µA
		C, E temperature ranges				8	
Input Voltage Range	V <sub>CM</sub>	C, E temperature ranges		-5.2		+3.5	V
		Single +5V	C, E temperature ranges	-0.2		+3.5	
Common-Mode Rejection Ratio	CMRR	-5.0V ≤ V <sub>CM</sub> ≤ +3.5V		80	110		dB
Power-Supply Rejection Ratio	PSRR	Positive supply; 4.5V ≤ V+ ≤ 5.5V		60	85		dB
		Negative supply; -2V ≥ V- ≥ -7V		80	100		
Small-Signal Voltage Gain	A <sub>V</sub>	1V ≤ V <sub>Q</sub> ≤ 2V, T <sub>A</sub> = +25°C		1500	3500		V/V
Output Voltage	V <sub>OH</sub>	V+ ≥ 4.5V	I <sub>OUT</sub> = 1mA	2.7	3.4		V
			I <sub>OUT</sub> = 10mA	2.4	3.0		
	V <sub>OL</sub>	I <sub>SINK</sub> = 4mA			0.3	0.5	
		T <sub>A</sub> = +25°C, I <sub>SINK</sub> = 10mA			0.4		
Positive Supply Current Per Comparator (Note 3)	I+	C, E temperature ranges			6	10	mA
Negative Supply Current Per Comparator (Note 3)	I-				1	2	mA
Latch-Pin High Input Voltage	V <sub>IH</sub>			2.0			V
Latch-Pin Low Input Voltage	V <sub>IL</sub>					0.8	V
Latch-Pin Current	I <sub>IL</sub>	V <sub>LE</sub> = 0V			-1	-20	µA

# Single/Dual, Ultra-Fast, Low-Power Precision TTL Comparators

MAX912/MAX913

## ELECTRICAL CHARACTERISTICS (continued)

V<sub>+</sub> = +5V, V<sub>-</sub> = -5V, V<sub>Q</sub> = 1.4V, V<sub>LE</sub> = 0V, T<sub>A</sub> = T<sub>MIN</sub> to T<sub>MAX</sub>, unless otherwise noted. Typical values are at T<sub>A</sub> = +25°C. (Note 1)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Propagation Delay (Note 4)	t <sub>PD+</sub> , t <sub>PD-</sub>	$\Delta V_{IN} = 100\text{mV}$ , V <sub>OD</sub> = 5mV	T <sub>A</sub> = +25°C		10	14	ns
			T <sub>A</sub> = T <sub>MIN</sub> TO T <sub>MAX</sub>			16	
		$\Delta V_{IN} = 100\text{mV}$ , V <sub>OD</sub> = 20mV	T <sub>A</sub> = +25°C		9	12	
			T <sub>A</sub> = T <sub>MIN</sub> TO T <sub>MAX</sub>			15	
Differential Propagation Delay (Note 4)	$\Delta t_{PD}$	$\Delta V_{IN} = 100\text{mV}$ , V <sub>OD</sub> = 5mV	T <sub>A</sub> = +25°C	MAX913	2	4	ns
				MAX912	3	5	
Channel-to-Channel Propagation Delay (Note 4)		$\Delta V_{IN} = 100\text{mV}$ , V <sub>OD</sub> = 5mV (MAX912 only)	T <sub>A</sub> = +25°C		500		ps
Latch Setup Time (Note 5)	t <sub>SU</sub>			2	0		ns
Latch Hold Time (Note 5)	t <sub>H</sub>			5	2		ns
Latch Propagation Delay (Note 6)	t <sub>LPD</sub>				7		ns

**Note 1:** All specifications are 100% tested at T<sub>A</sub> = +25°C, unless otherwise noted. Specification limits over temperature (T<sub>A</sub> = T<sub>MIN</sub> to T<sub>MAX</sub>) are guaranteed by design.

**Note 2:** Input Offset Voltage (V<sub>OS</sub>) is defined as the average of the two input offset voltages, measured by forcing first one output, then the other to 1.4V. Input Offset Current (I<sub>OS</sub>) is defined the same way.

**Note 3:** Supply currents are measured with V<sub>Q</sub> driven to both V<sub>OH</sub> and V<sub>OL</sub> (not 1.4V).

**Note 4:** Propagation Delay (t<sub>PD</sub>) and Differential Propagation Delay ( $\Delta t_{PD}$ ) cannot be measured in automatic handling equipment with low input overdrive values. Characterization and correlation tests have shown that t<sub>PD</sub> and  $\Delta t_{PD}$  limits can be guaranteed by design. Electrical Characteristic DC tests are performed to guarantee that all internal bias conditions are correct. For low overdrive conditions, V<sub>OS</sub> is added to overdrive. Differential Propagation Delay is defined as  $\Delta t_{PD} = t_{PD+} - t_{PD-}$ .

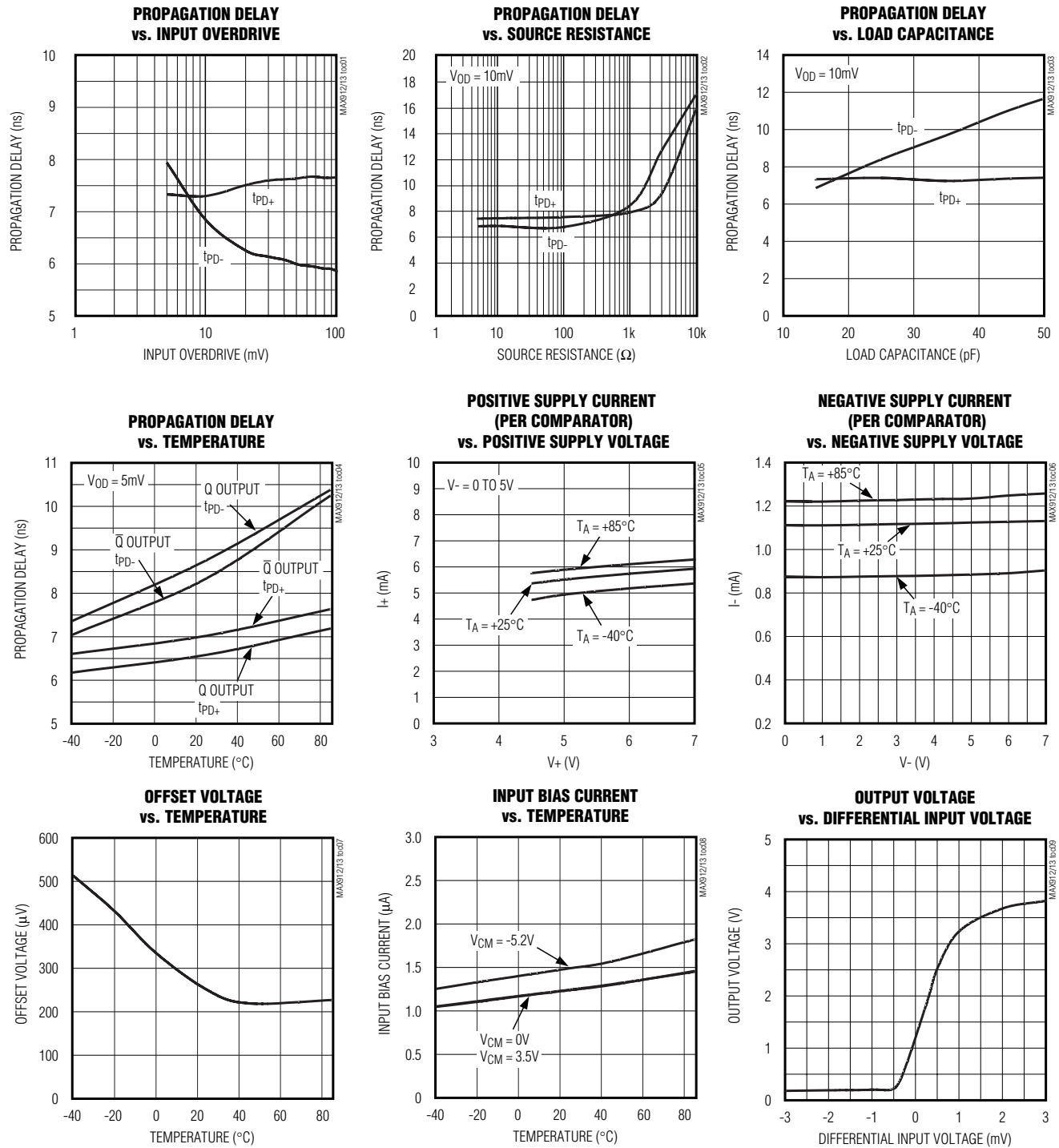
**Note 5:** Input latch setup time (t<sub>SU</sub>) is the interval in which the input signal must be stable prior to asserting the latch signal. The hold time (t<sub>H</sub>) is the interval after the latch is asserted in which the input signal must be stable. These parameters are guaranteed by design.

**Note 6:** Latch Propagation Delay (t<sub>LPD</sub>) is the delay time for the output to respond when the latch-enable pin is deasserted (see Timing Diagram).

# Single/Dual, Ultra-Fast, Low-Power Precision TTL Comparators

## Typical Operating Characteristics

( $V_+ = +5V$ ,  $V_- = -5V$ ,  $V_{LE} = 0V$ ,  $C_L = 15pF$ ,  $T_A = +25^\circ C$ , unless otherwise noted.)

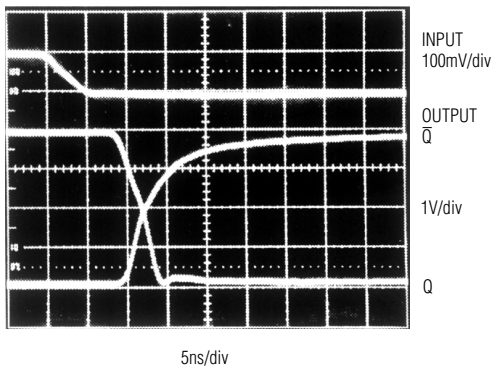


# Single/Dual, Ultra-Fast, Low-Power Precision TTL Comparators

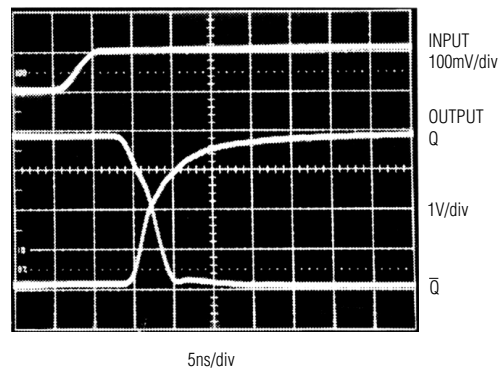
## Typical Operating Characteristics (continued)

( $V_+ = +5V$ ,  $V_- = -5V$ ,  $V_{LE} = 0V$ ,  $C_L = 15pF$ ,  $T_A = +25^\circ C$ , unless otherwise noted.)

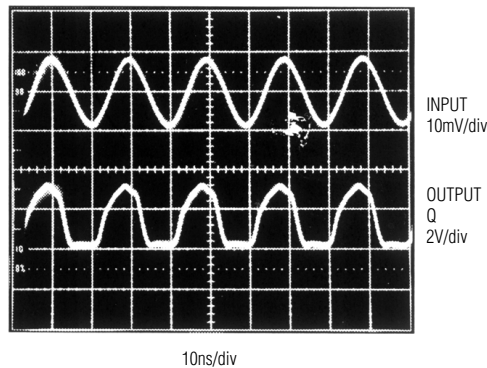
**POSITIVE-TO-NEGATIVE PROPAGATION DELAY**



**NEGATIVE-TO-POSITIVE PROPAGATION DELAY**

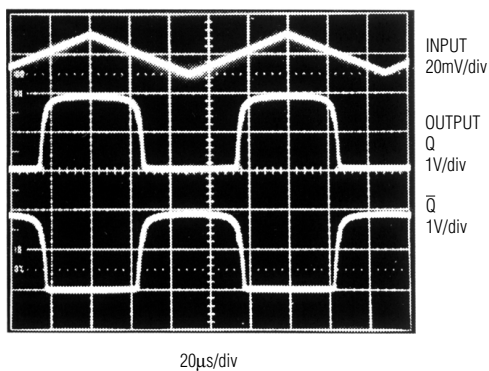


**MAX912/MAX913 RESPONSE TO 50MHZ ( $\pm 10mV_{p-p}$ ) SINE WAVE**

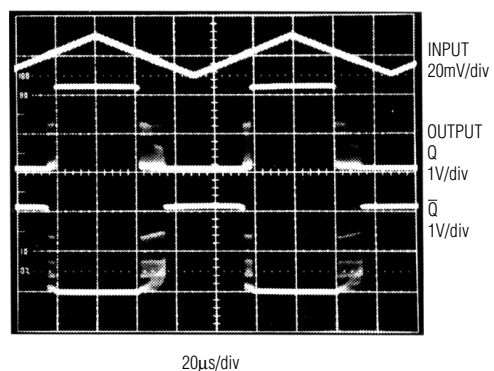


**MAX912/MAX913 RESPONSE TO SLOW-MOVING TRIANGLE WAVE**

**MAX912/MAX913 RESPONSE**



**INDUSTRY-STANDARD 686 RESPONSE**



**MAX912/MAX913**

# Single/Dual, Ultra-Fast, Low-Power Precision TTL Comparators

## MAX912 Pin Description

PIN	NAME	FUNCTION
1	QA	Comparator A TTL Output
2	$\overline{Q}A$	Comparator A Complementary TTL Output
3, 14	GND	Logic Ground. Connect <b>both</b> GND pins to ground.
4	LEA	Comparator A Latch Enable. QA and $\overline{Q}A$ are latched when LEA is TTL high or floating. Comparator A latch is transparent when LEA is low.
5, 12	N.C.	No Connection. Not internally connected.
6	V-	Negative Power Supply. -5V for dual supplies (bypass to GND with a 0.1 $\mu$ F capacitor) or GND for a single supply.
7	INA-	Comparator A Inverting Input
8	INA+	Comparator A Noninverting Input
9	INB+	Comparator B Noninverting Input
10	INB-	Comparator B Inverting Input
11	V+	Positive Power Supply, +5V. Bypass to GND with a 0.1 $\mu$ F capacitor.
13	LEB	Comparator B Latch Enable. QB and $\overline{Q}B$ are latched when LEB is TTL high or floating. Comparator B latch is transparent when LEB is low.
15	$\overline{Q}B$	Comparator B Complementary TTL Output
16	QB	Comparator B TTL Output

## MAX913 Pin Description

PIN	NAME	FUNCTION
1	V+	Positive Power Supply. Bypass to GND with a 0.1 $\mu$ F capacitor.
2	IN+	Noninverting Input
3	IN-	Inverting Input
4	V-	Negative Power Supply. -5V for dual supplies (bypass to GND with a 0.1 $\mu$ F capacitor) or GND for a single supply.
5	LE	Latch Enable. Q and $\overline{Q}$ are latched when LE is TTL high or floating. The comparator latch is transparent when LE is low.
6	GND	Logic Ground
7	Q	TTL Output
8	$\overline{Q}$	Complementary TTL Output

# Single/Dual, Ultra-Fast, Low-Power Precision TTL Comparators

MAX912/MAX913

## Detailed Description

The MAX912 (dual) and MAX913 (single) high-speed comparators have a unique design that prevents oscillation when the comparator is in its linear region. No minimum input slew rate is required.

Many high-speed comparators oscillate in the linear region, as shown in the *Typical Operating Characteristics*' industry-standard 686 response graph. One way to overcome this oscillation is to sample the output after it has passed through the unstable region. Another practical solution is to add hysteresis. Either solution results in a loss of resolution and bandwidth.

Because the MAX912/MAX913 do not need hysteresis, they offer high resolution to all signals—including low-frequency signals.

The MAX912/MAX913 provide a TTL-compatible latch function that holds the comparator output state (Figure 1). As long as Latch Enable (LE) is high or floating, the input signal has no effect on the output state. With LE low, the outputs are controlled by the input differential voltage and the latch is transparent.

## Input Amplifier

A comparator can be thought of as having two sections; an input amplifier and a logic interface. The MAX912/MAX913's input amplifier is fully differential with input offset voltage trimmed to below 2.0mV at

+25°C. Input common-mode range extends from 200mV **below** the negative supply rail to 1.5V below the positive power supply. The total common-mode range is 8.7V when operating from  $\pm 5\text{VDC}$  supplies.

The MAX912/MAX913's amplifier has no built-in hysteresis. For highest accuracy, do not add hysteresis. Figure 2 shows how hysteresis degrades resolution.

## Resolution

A comparator's ability to resolve small signal differences—its resolution—is affected by various factors. As with most amplifiers, the most significant factors are the input offset voltage ( $V_{OS}$ ) and the common-mode and power-supply rejection ratios (CMRR, PSRR). If source impedance is high, input offset current can be significant. If source impedance is unbalanced, the input bias current can introduce another error.

For high-speed comparators, an additional factor in resolution is the comparator's stability in its linear region. Many high-speed comparators are useless in their linear region because they oscillate. This makes the differential input voltage region around 0V unusable, as does a high  $V_{OS}$ . Hysteresis does not cure the problem, but acts to keep the input away from its linear range (Figure 2).

The MAX912/MAX913 do not oscillate in the linear region, which greatly enhances the comparator's resolution.

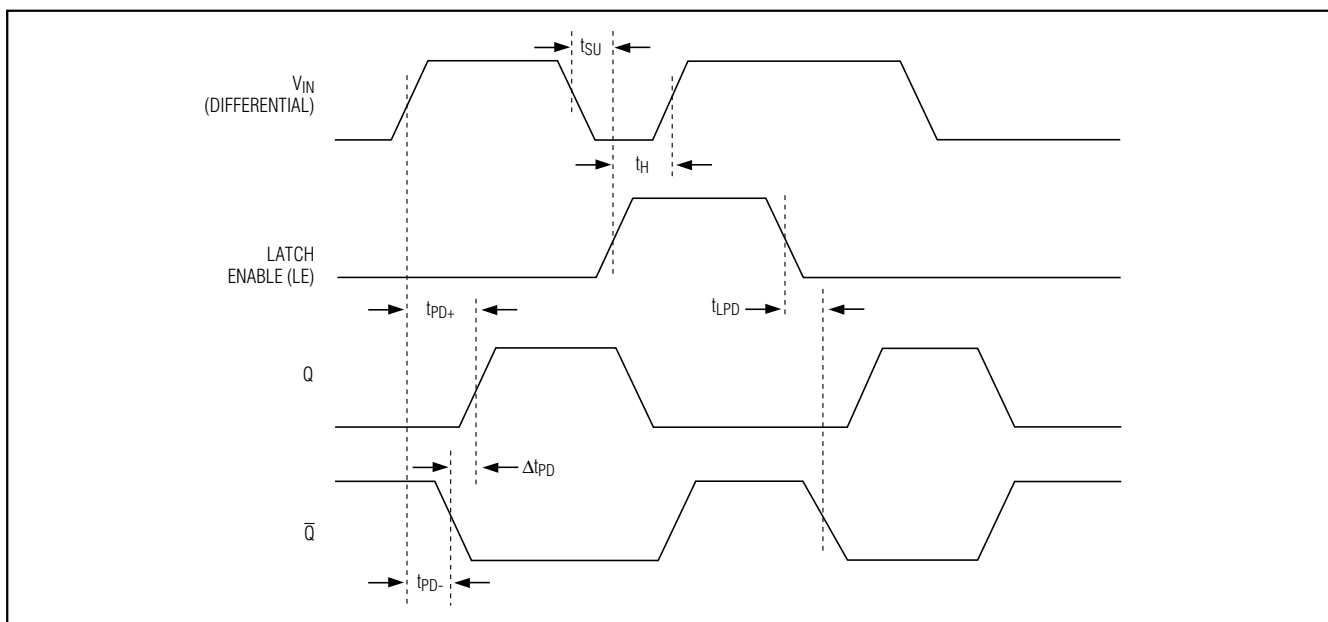


Figure 1. Timing Diagram

# Single/Dual, Ultra-Fast, Low-Power Precision TTL Comparators

## Applications Information

### Power Supplies and Bypassing

The MAX912/MAX913 are tested with  $\pm 5V$  power supplies that provide an input common-mode range ( $V_{CM}$ ) of 8.7V (-5.2V to +3.5V). Operation from a single +5V supply provides a common-mode input range of 3.7V (-0.2V to +3.5). Connect  $V_-$  to GND for single-supply operation. The MAX912/MAX913 will operate from a minimum single-supply voltage of +4.5V.

The  $V_+$  supply provides power to both the analog input stage and digital output circuits, whereas the  $V_-$  supply only powers the analog section. Bypass  $V_+$  and  $V_-$  to ground with 0.1 $\mu F$  to 1.0 $\mu F$  ceramic capacitors in parallel with 10 $\mu F$  or greater tantalum capacitors. Connect the ceramic capacitors very close to the MAX912/MAX913's supply pins, keeping leads short to minimize lead inductance. For particularly noisy applications, use ferrite beads on the power-supply lines.

### Board Layout

As with all high-speed components, careful attention to layout is essential for best performance.

- 1) Use a printed circuit board with an unbroken ground plane.
- 2) Pay close attention to the bandwidth of bypass components and keep leads short.
- 3) Avoid sockets; solder the comparator and other components directly to the board to minimize unwanted parasitic inductance and capacitance.

### Input Slew Rate

The MAX912/MAX913 design eliminates the input slew-rate requirement imposed on many standard comparators. As long as  $LE$  is high after the maximum propagation delay and the input is greater than the comparator's total DC error, the output will be valid without oscillations.

### Maximum Clock ( $LE$ ) and Signal Rate

The maximum clock and signal rate is 70MHz, based on the comparator's rise and fall time with a 5mV overdrive at +25°C (Figure 1). With a 20mV overdrive, the maximum propagation delay is 12ns and the clock signal rate is 85MHz.

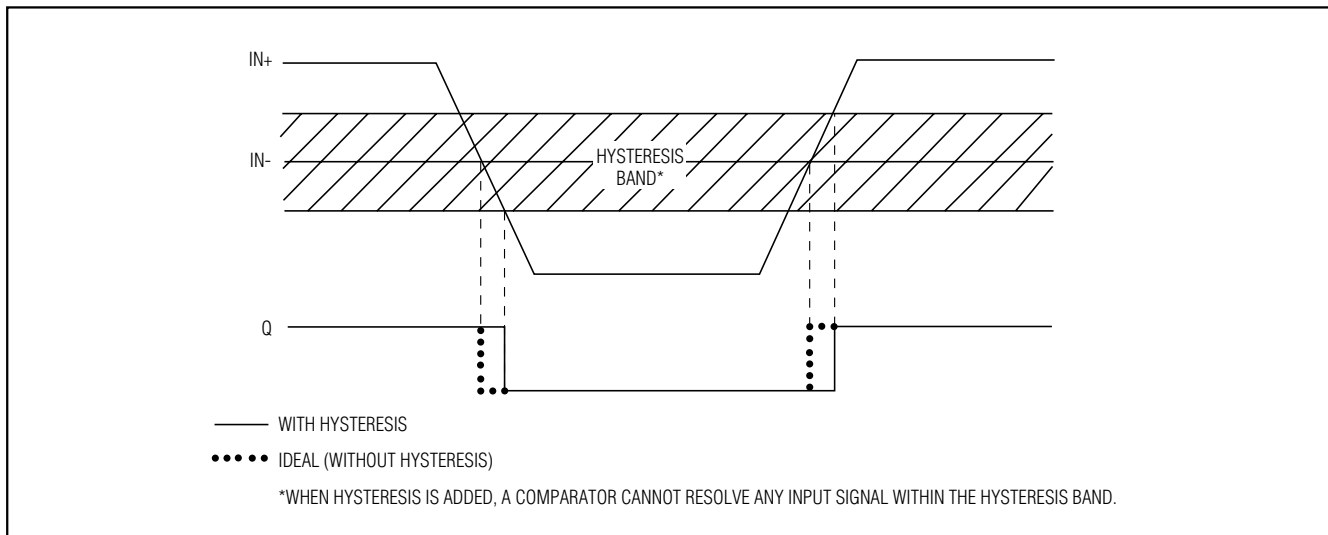


Figure 2. Effect of Hysteresis on Input Resolution

## Chip Information

MAX912 TRANSISTOR COUNT: 285

MAX913 TRANSISTOR COUNT: 154

PROCESS: Bipolar

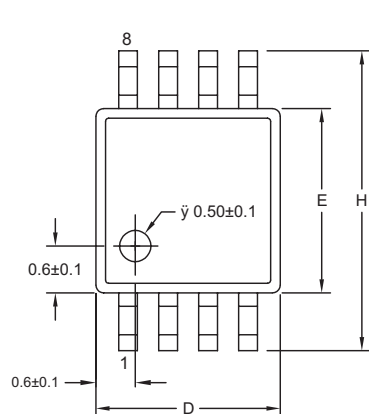
# Single/Dual, Ultra-Fast, Low-Power Precision TTL Comparators

## Package Information

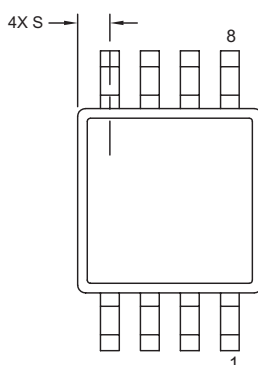
(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to [www.maxim-ic.com/packages](http://www.maxim-ic.com/packages).)

MAX912/MAX913

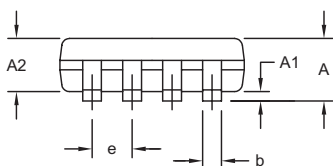
8LUMAXD.EPS



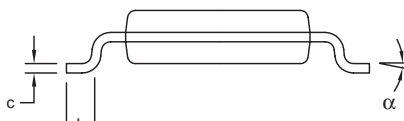
TOP VIEW



BOTTOM VIEW



FRONT VIEW



SIDE VIEW

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	-	0.043	-	1.10
A1	0.002	0.006	0.05	0.15
A2	0.030	0.037	0.75	0.95
b	0.010	0.014	0.25	0.36
c	0.005	0.007	0.13	0.18
D	0.116	0.120	2.95	3.05
e	0.0256 BSC		0.65 BSC	
E	0.116	0.120	2.95	3.05
H	0.188	0.198	4.78	5.03
L	0.016	0.026	0.41	0.66
α	0°	6°	0°	6°
S	0.0207 BSC		0.5250 BSC	

### NOTES:

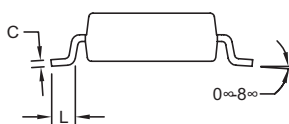
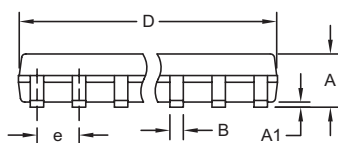
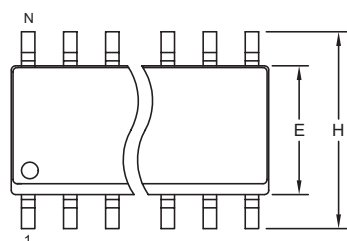
1. D&E DO NOT INCLUDE MOLD FLASH.
2. MOLD FLASH OR PROTRUSIONS NOT TO EXCEED 0.15MM (.006").
3. CONTROLLING DIMENSION: MILLIMETERS.
4. MEETS JEDEC MO-187C-AA.

PROPRIETARY INFORMATION		
TITLE:		
PACKAGE OUTLINE, 8L uMAX/uSOP		
APPROVAL	DOCUMENT CONTROL NO.	REV.
	21-0036	J 1/1

# Single/Dual, Ultra-Fast, Low-Power Precision TTL Comparators

## Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to [www.maxim-ic.com/packages](http://www.maxim-ic.com/packages).)



DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.053	0.069	1.35	1.75
A1	0.004	0.010	0.10	0.25
B	0.014	0.019	0.35	0.49
C	0.007	0.010	0.19	0.25
e	0.050 BSC		1.27 BSC	
E	0.150	0.157	3.80	4.00
H	0.228	0.244	5.80	6.20
L	0.016	0.050	0.40	1.27

VARIATIONS:

DIM	INCHES		MILLIMETERS		N	MS012
	MIN	MAX	MIN	MAX		
D	0.189	0.197	4.80	5.00	8	AA
D	0.337	0.344	8.55	8.75	14	AB
D	0.386	0.394	9.80	10.00	16	AC

### NOTES:

1. D&E DO NOT INCLUDE MOLD FLASH.
2. MOLD FLASH OR PROTRUSIONS NOT TO EXCEED 0.15mm (.006").
3. LEADS TO BE COPLANAR WITHIN 0.10mm (.004").
4. CONTROLLING DIMENSION: MILLIMETERS.
5. MEETS JEDEC MS012.
6. N = NUMBER OF PINS.

PROPRIETARY INFORMATION	
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PACKAGE OUTLINE, .150" SOIC	
APPROVAL	DOCUMENT CONTROL NO.
	21-0041
REV.	1/1
B	

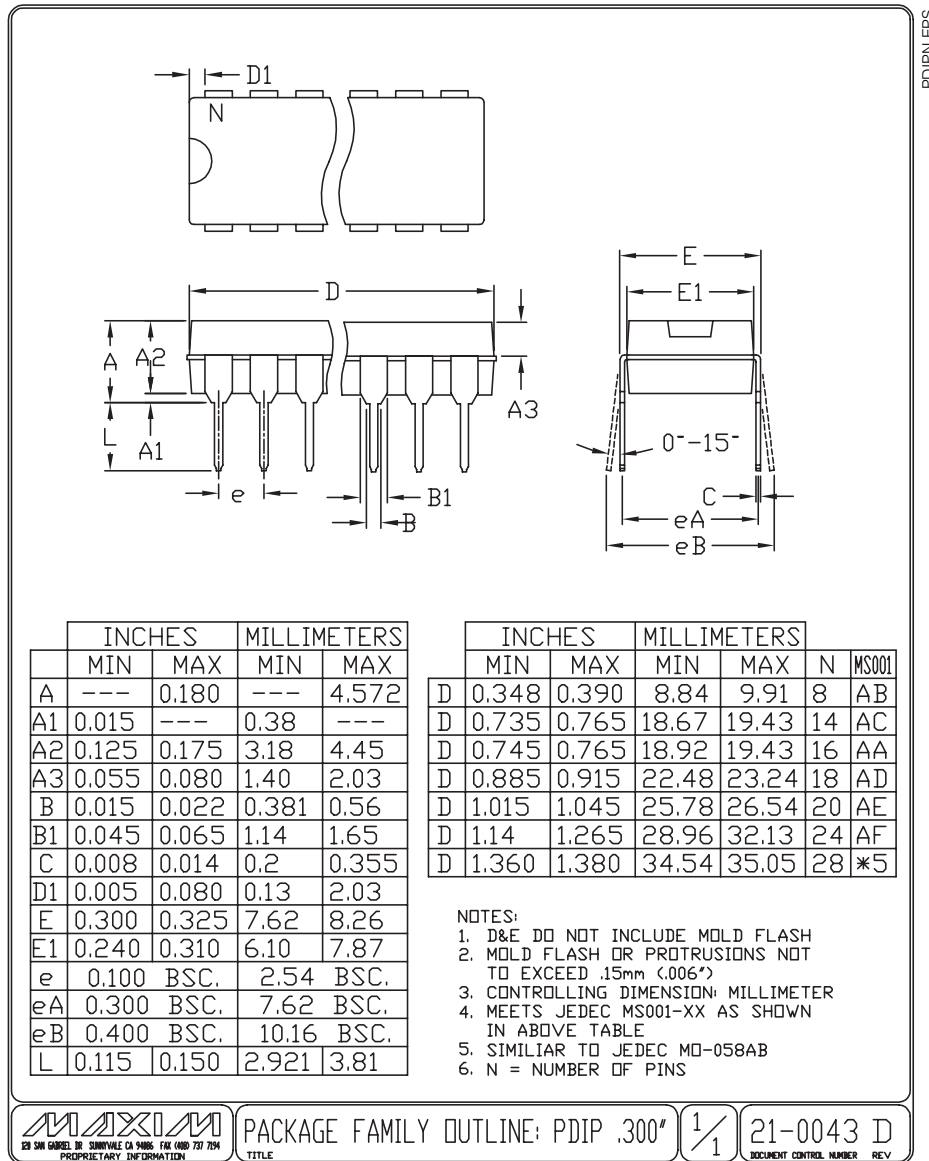
SOICN.EPS

# Single/Dual, Ultra-Fast, Low-Power Precision TTL Comparators

## Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to [www.maxim-ic.com/packages](http://www.maxim-ic.com/packages).)

MAX912/MAX913



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